

# ELECTROSTATIC POTENTIAL AND CAPACITANCE MINDMAP.

## # Electric Potential (V) →

• Work done in moving a unit (+ve) charge from infinity to point.

• Point Charge,  $V = \frac{Kq}{r}$

• Ring

→ At center,  $V = \frac{Kq}{r}$

→ Along axis,  $V = \frac{Kq}{\sqrt{r^2 + x^2}}$

• Electric Dipole

→  $V_{\text{axial}} = \frac{Kp}{r^2}$

→  $V_{\text{equatorial}} = 0$

• Hollow Sphere / Metallic Conductor

$V = \frac{Kq}{R}$  ( $r \leq R$ )

$V = \frac{Kq}{r}$  ( $r \geq R$ )

## # Electric Potential Energy →

• Two point charges,  $U_{12} = \frac{Kq_1q_2}{r}$  (with sign consider)

• Multiple charges,

$U = U_{12} + U_{13} + U_{23} + \dots$

• Dipole in ext field  $U = -\vec{p} \cdot \vec{E}$

• Energy Conservation

## # Dielectrics and Polarisation →

• Dielectric: Non conducting substance.

• For dielectric,  $\vec{E}_{\text{net, inside}} \neq 0$

$\vec{E}_{\text{induced}} = -\frac{\vec{E}_{\text{ext}}}{K}$

• Polarisation  $\vec{P} = \chi \vec{E}$

(dipole moment per unit volume)

## # Capacitor (Charge Storage Device) →

$$C = \frac{Q}{V}$$

• Parallel plate Capacitor

• Air medium,  $C = \frac{A\epsilon_0}{d}$

• Dielectric completely filled b/w plates,

$$C = \frac{KA\epsilon_0}{d}$$

• Dielectric filled upto thickness  $t$  and same area as plates,

$$C = \frac{A\epsilon_0}{d-t\left[1-\frac{1}{K}\right]}$$

• Series/parallel combination.

• Energy stored  $E = \frac{Q^2}{2C} = \frac{V^2 C}{2}$

• RC Circuit

In Charging

At  $t=0$ ,  $C$  as wire.

$t=\infty$ ,  $C$  as open circuit.

(Initially uncharged capacitor)

## # Electrostatics Of Conductors: →

$$E_{\text{inside}} = 0$$

$$E_{\text{surface}} = \frac{\sigma}{\epsilon_0} \text{ (along normal direction)}$$

• Excess charge only on surface.

$$V_{\text{inside}} = V_{\text{surface}}$$

• Electrostatic Shielding

( $E$  inside uncharged cavity is always 0)

## # Potential Difference and Field →

$$\Delta V = V_f - V_i$$

$$dV = -\vec{E} \cdot d\vec{r} \text{ or } E = -\frac{dV}{dr}$$

• Work done in moving charge  $q$ ,

$$W = q \Delta V$$

• Equipotential Surfaces.



NEET  
SLAYER